





0.2A SBR[®] SUPER BARRIER RECTIFIER

Features

- Low Forward Voltage Drop
- Superior Reverse Avalanche Capability
- Patented Super Barrier Rectifier Technology
- Soft, Fast Switching Capability
- 150°C Operating Junction Temperature
- Lead Free Finish, RoHS Compliant
- "Green" Molding Compound (No Br, Sb)



- Case: SOD-523
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020D
- Polarity Indicator: Cathode Band
- Terminals: Finish Matte Tin annealed over Alloy 42
 leadframe. Solderable per MIL-STD-202, Method 208
 3
- Marking Information: See Page 2Ordering Information: See Page 2
- Weight: 0.002 grams (approximate)



Top View



Bottom View

Maximum Ratings @T_A = 25°C unless otherwise specified

Single phase, half wave, 60Hz, resistive or inductive load. For capacitance load, derate current by 20%.

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _{RWM} V _{RM}	20	V
RMS Reverse Voltage	V _{R(RMS)}	14	V
Average Rectified Output Current (See Figure 1)	Io	0.2	Α
Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load	I _{FSM}	5	А

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Maximum Thermal Resistance Thermal Resistance Junction to Soldering (Note 1)	$R_{ hetaJA}$	400	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-65 to +150	°C

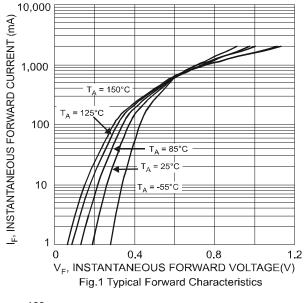
Electrical Characteristics @TA = 25°C unless otherwise specified

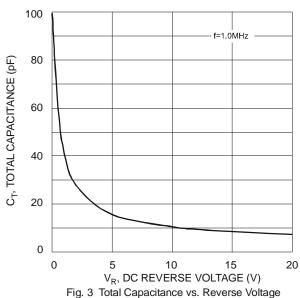
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 2)	V _{(BR)R}	20	-	-	V	$I_R = 400 \mu A$
Forward Voltage Drop	V _F	-	0.37 0.34 0.43 0.41	0.41 0.38 0.47 0.45	V	I _F = 0.1A, T _J = 25°C I _F = 0.1A, T _J = 85°C I _F = 0.2A, T _J = 25°C I _F = 0.2A, T _J = 85°C
Leakage Current (Note 2)	I _R	-	-	40 0.5		$V_R = 20V, T_J = 25^{\circ}C$ $V_R = 20V, T_J = 85^{\circ}C$

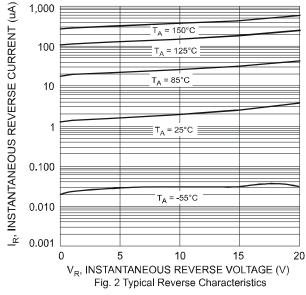
Notes:

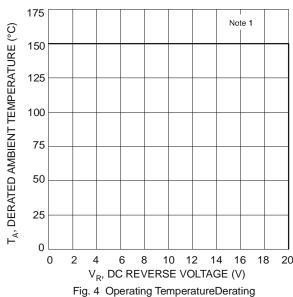
- 1. FR-4 PCB, 2 oz. Copper, minimum recommended pad layout per http://www.diodes.com/datasheets/ap02001.pdf.
- 2. Short duration pulse test used to minimize self-heating effect.











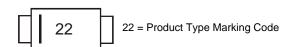
Ordering Information (Note 3)

Part Number	Case	Packaging
SBR0220T5-7 (Note 4)	SOD-523	3000/Tape & Reel

Notes:

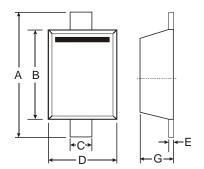
3. For packaging details, go to our website at http://www.diodes.com/datasheets/ap02007.pdf. 4. Dispensed in every other cavity of the tape.

Marking Information



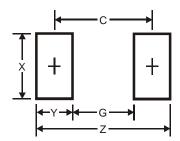


Package Outline Dimensions



	SOD-523		
Dim	Min	Max	
Α	1.50	1.70	
В	1.10	1.30	
С	0.25	0.35	
D	0.70	0.90	
E	0.10	0.20	
G	0.50	0.70	
All Dimensions in mm			

Suggested Pad Layout



Dimensions	Value (in mm)
Z	2.3
G	1.1
х	0.8
Y	0.6
С	1.7

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